L Number	Hits	Search Text	DB	Time stamp
2	2113229	resistance neatemperature	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/19 15:00
3	32732	resistance near temperature	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/19 15:00
4	532	increasing near temperature near rapidly	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/19 15:01
5	65	ceramic and gas adj sensor and (heater or heating adj element) near embedded	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/19 15:02
6	0	(increasing near temperature near rapidly) and (ceramic and gas adj sensor and (heater or heating adj element) near embedded)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/19 15:02
7	14	<pre>(resistance near temperature) and (increasing near temperature near rapidly)</pre>	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/19 15:02
8	0	(ceramic and gas adj sensor and (heater or heating adj element) near embedded) and ((resistance near temperature) and (increasing near temperature near rapidly))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/19 15:02
9	501	ceramic and gas adj sensor and embedded	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/19 15:02
10	0	((resistance near temperature) and (increasing near temperature near rapidly)) and (ceramic and gas adj sensor and embedded)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/19 15:02
11	118478	219/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/19 15:03
12	122	heating near gas near sensor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/19 15:03
13	4	(ceramic and gas adj sensor and heat\$ near embedded) and (heating near gas near sensor)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/19 15:06
15	0	(increasing near temperature near rapidly) and ((ceramic and gas adj sensor and embedded) and 219/\$.ccls.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/19 15:06
17	3	((resistance near temperature) and (increasing near temperature near rapidly)) and 219/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/19 15:06

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16	25	`	USPAT;	2004/08/19
		rapidly) and 219/\$.ccls.	US-PGPUB;	15:08
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	0004/00/10
14	16	1 '	USPAT;	2004/08/19
		and 219/\$.ccls.	US-PGPUB;	15:33
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
20	2	1	USPAT;	2004/08/19
		rapidly	US-PGPUB;	15:35
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
19	2	1	USPAT;	2004/08/19
		slowly	US-PGPUB;	15:36
			EPO; JPO;	i
			DERWENT;	
			IBM_TDB	
18	1	<u></u>	USPAT;	2004/08/19
		temperature adj heater	US-PGPUB;	15:35
			EPO; JPO;	
			DERWENT;	<u> </u>
			IBM_TDB	
21	72		USPAT;	2004/08/19
		(ceramic and gas adj sensor and embedded)	US-PGPUB;	15:37
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	0004/00/10
22	4	1 = = - / , , ,	USPAT;	2004/08/19
		temperature) and (ceramic and gas adj	US-PGPUB;	15:38
		sensor and embedded))	EPO; JPO;	
			DERWENT;	
			IBM_TDB	2004/08/19
23	27228	controlling and measuring and resistance	USPAT;	15:39
		and rate and increasing and temperature	US-PGPUB;	15:39
			EPO; JPO;	
			DERWENT;	
		and and add course and bast's	IBM_TDB	2004/08/19
24	0		USPAT; US-PGPUB;	15:40
		embedded21 and (controlling and measuring and resistance and rate and increasing	EPO; JPO;	13.70
	1		DERWENT;	
		and temperature)	IBM TDB	
2 5	12	(/registence near temperature) and	USPAT;	2004/08/19
25	12	((resistance near temperature) and (ceramic and gas adj sensor and	US-PGPUB;	15:45
		embedded)) and (controlling and measuring	EPO; JPO;	10.10
		and resistance and rate and increasing	DERWENT;	
		and resistance and fate and increasing and temperature)	IBM TDB	
26	642		USPAT;	2004/08/19
20	642	measuring and resistance and rate and	US-PGPUB;	15:45
	[increasing and temperature)	EPO; JPO;	
		thereasing and competature,	DERWENT;	
	[·	IBM TDB	
27	1	(ceramic and gas adj sensor and embedded)	USPAT;	2004/08/19
41		and (219/\$.ccls. and (controlling and	US-PGPUB;	15:45
		measuring and resistance and rate and	EPO; JPO;	
		increasing and temperature))	DERWENT;	
	1	Thoroading and comporatory	IBM TDB	[
l .	1			<u> </u>

L	Hits	Search Text	DB	Time stamp
Number 2	2113229	resistance neatemperature	USPAT;	2004/08/19
	2113223		US-PGPUB;	15:00
			EPO; JPO;	
			DERWENT;	
3	32732	resistance near temperature	IBM_TDB USPAT;	2004/08/19
]	32/32	Teststance hear temperature	US-PGPUB;	15:00
			EPO; JPO;	
			DERWENT;	
	F33	ingressing many temperature were used at a	IBM_TDB USPAT;	2004/08/19
4	532	increasing near temperature near rapidly	USPAT; US-PGPUB;	15:01
			EPO; JPO;	
1			DERWENT;	
			IBM_TDB	2004/09/10
5	65	ceramic and gas adj sensor and (heater or heating adj element) near embedded	USPAT; US-PGPUB;	2004/08/19 15:02
		nearing adjetement, near embedded	EPO; JPO;	10.02
			DERWENT;	
_			IBM_TDB	0004/00/120
6	0	(increasing near temperature near	USPAT; US-PGPUB;	2004/08/19 15:02
		rapidly) and (ceramic and gas adj sensor and (heater or heating adj element) near	EPO; JPO;	13.02
		embedded)	DERWENT;	
			IBM_TDB	
7	14	(resistance near temperature) and	USPAT;	2004/08/19
		(increasing near temperature near rapidly)	US-PGPUB; EPO; JPO;	15:02
		rapidity)	DERWENT;	
			IBM_TDB	
8	0	(ceramic and gas adj sensor and (heater	USPAT;	2004/08/19
		or heating adj element) near embedded)	US-PGPUB;	15:02
		and ((resistance near temperature) and (increasing near temperature near	EPO; JPO; DERWENT;	
		rapidly))	IBM_TDB	
9	501	ceramic and gas adj sensor and embedded	USPĀT;	2004/08/19
			US-PGPUB;	15:02
			EPO; JPO; DERWENT;	
		·	IBM TDB	
10	0	((resistance near temperature) and	USPAT;	2004/08/19
		(increasing near temperature near	US-PGPUB;	15:02
		rapidly)) and (ceramic and gas adj sensor and embedded)	EPO; JPO; DERWENT;	
		and embedded;	IBM TDB	
11	118478	219/\$.ccls.	USPĀT;	2004/08/19
			US-PGPUB;	15:03
			EPO; JPO; DERWENT;	
			IBM TDB	
12	122	heating near gas near sensor	USPAT;	2004/08/19
			US-PGPUB;	15:03
			EPO; JPO; DERWENT;	
			IBM TDB	
13	4	(ceramic and gas adj sensor and heat\$	USPAT;	2004/08/19
		near embedded) and (heating near gas near	US-PGPUB;	15:06
		sensor)	EPO; JPO;	
			DERWENT; IBM TDB	
15	0	(increasing near temperature near	USPAT;	2004/08/19
		rapidly) and ((ceramic and gas adj sensor	US-PGPUB;	15:06
		and embedded) and 219/\$.ccls.)	EPO; JPO;	
			DERWENT; IBM TDB	
17	3	((resistance near temperature) and	USPAT;	2004/08/19
- '	Ĭ	(increasing near temperature near	US-PGPUB;	15:06
		rapidly)) and 219/\$.ccls.	EPO; JPO;	
			DERWENT; IBM TDB	
			T DIA T DD	L

16	25	(increasing near temperature near	USPAT;	2004/08/19
		rapidly) and 219/\$.ccls.	US-PGPUB;	15:08
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
14	16	(ceramic and gas adj sensor and embedded)	USPĀT;	2004/08/19
		and 219/\$.ccls.	US-PGPUB;	15:14
			EPO; JPO;	
			DERWENT;	
			IBM TDB	